

1-18-07

01-24-2007

FORM PTO-1595
(Rev. 08/05)



U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office

Docket No.: 075905-0030

103364700

To the Director of the U. S. Patent and T

Documents or the new address(es) below.

1. Name of Conveying Party(ies)

Motohiro YAMAZAKI, Ryoji INABA, Satoshi TAKAHASHI,
Shigeru MATSUI

Additional name(s) of conveying party(ies) attached? ☐ Yes ☐ No

3. Nature of Conveyance/Execution Date(s)

Execution Date(s): December 7, 2006, December 7, 2006,
December 8, 2006, December 8, 2006
(respectively)

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Joint Research Agreement
☐ Government Interest Assignment
☐ Executive Order 9424, Confirmatory License
☐ Other

2. Name and address of receiving party(ies)

Name: HITACHI HIGH-TECHNOLOGIES
CORPORATION

Address: 1-24-14, Nishi Shimbashi,
Minato-ku,

Tokyo, JAPAN

Additional name(s) & address(es) attached? ☐ Yes ☐ No

4. Application or patent number(s):

A. Patent Application No(s).

☐ This document is being filed together with a new application.

B. Patent No(s).

Additional numbers attached? ☐ Yes ☐ No

5. Name and address to whom correspondence concerning
document should be mailed:

Name: MCDERMOTT WILL & EMERY LLP

Internal Address:

Street Address: 600 13th Street, N.W.

City: Washington State: D. C. Zip: 20005-3096

Phone Number: 202.756.8000

Fax Number: 202.756.8087

Email Address:

6. Total number of applications and patents
involved:

7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00

- ☐ Authorized to be charged by credit card
☒ Authorized to be charged to deposit account
☐ Enclosed
☐ None required (government interest not affecting title)nt

8. Payment Information:

- a. Credit Card Last 4 Numbers 500417
Expiration Date
b. Deposit Account Number 500417
Authorized User Name

9. Signature.

Keith E. George, 34,111

Name and Registration No. of Person Signing

Signature

January 23, 2007

Date

Total number of pages including cover sheet, attachments and documents: 2

OMB No. 0651-0027 (exp. 6/30/2008)

113013 U.S. PTO
11/654683
011807

11654683

00000141 500417

40.00 DA

01/23/2007

01 FC-8021

ASSIGNMENT
(譲 渡 証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi High-Technologies Corporation, a corporation organized under the laws of Japan, located at 1-24-14, Nishi Shimbashi, Minato-ku, Tokyo, Japan receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi High-Technologies Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

CAPILLARY ELECTROPHORESIS APPARATUS AND ELECTROPHORESIS METHOD

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi High-Technologies Corporation, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi High-Technologies Corporation,

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)
(発明者フルネームサイン)

Date Signed
(署名日)

1)	<i>Motohiro Yamazaki</i>	<i>12/7/2006</i>
2)	<i>Reiji Inaba</i>	<i>12/7/2006</i>
3)	<i>Satoshi Takahashi</i>	<i>12/8/2006</i>
4)	<i>Shigenori Matsui</i>	<i>12/8/2006</i>
5)		
6)		
7)		
8)		
9)		
10)		